

1.1A Step-Up DC/DC Converter with Integrated Soft-Start

FEATURES

- **1.3MHz Switching Frequency (LT3467)**
- **2.1MHz Switching Frequency (LT3467A)**
- **Low V_{CESAT} Switch: 330mV at 1.1A**
- **High Output Voltage: Up to 40V**
- **Wide Input Range: 2.4V to 16V**
- **Dedicated Soft-Start Pin**
- 5V at 540mA from 3.3V Input (LT3467)
- 5V at 430mA from 3.3V Input (LT3467A)
- 12V at 270mA from 5V Input (LT3467)
- 12V at 260mA from 5V Input (LT3467A)
- Uses Small Surface Mount Components
- Low Shutdown Current: <math><1\mu A</math>
- Pin-for-Pin Compatible with the LT1930 and LT1613
- Low Profile (1mm) ThinSOT™ Package
- Low Profile (0.75mm) 8-Lead (3mm × 2mm) DFN Package
- AEC-Q100 Qualified for Automotive Applications

APPLICATIONS

- Digital Cameras
- White LED Power Supplies
- Cellular Phones
- Medical Diagnostic Equipment
- Local 5V or 12V Supplies
- TFT-LCD Bias Supplies
- xDSL Power Supplies

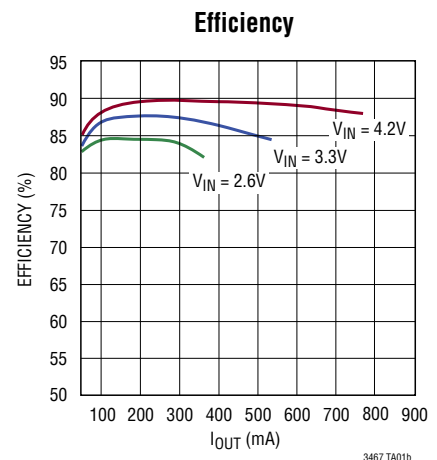
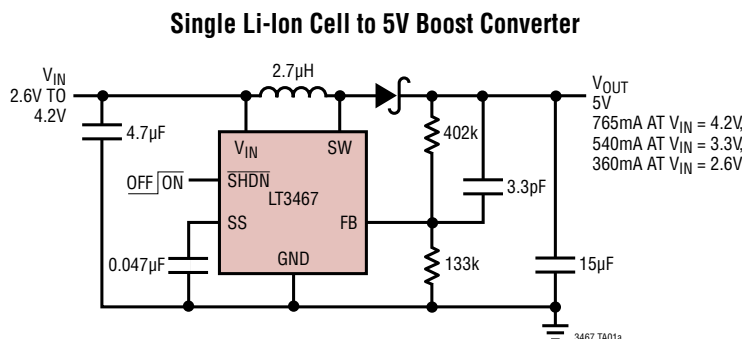
DESCRIPTION

The **LT[®]3467/LT3467A** switching regulators combine a 42V, 1.1A switch with a soft-start function. Pin compatible with the LT1930, its low V_{CESAT} bipolar switch enables the device to deliver high current outputs in a small footprint. The LT3467 switches at 1.3MHz, allowing the use of tiny, low cost and low height inductors and capacitors. The LT3467A switches at 2.1MHz, allowing the use of even smaller components. High inrush current at start-up is eliminated using the programmable soft-start function. A single external capacitor sets the current ramp rate. A constant frequency current mode PWM architecture results in low, predictable output noise that is easy to filter.

The high voltage switch on the LT3467/LT3467A is rated at 42V, making the devices ideal for boost converters up to 40V as well as SEPIC and flyback designs. The LT3467 can generate 5V at up to 540mA from a 3.3V supply or 5V at 450mA from four alkaline cells in a SEPIC design. The LT3467A can generate 5V at up to 430mA from a 3.3V supply or 15V at 135mA from a 3.3V supply. The LT3467/LT3467A are available in a low profile (1mm) 6-lead SOT-23 package and tiny 3mm × 2mm DFN package.

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TYPICAL APPLICATION



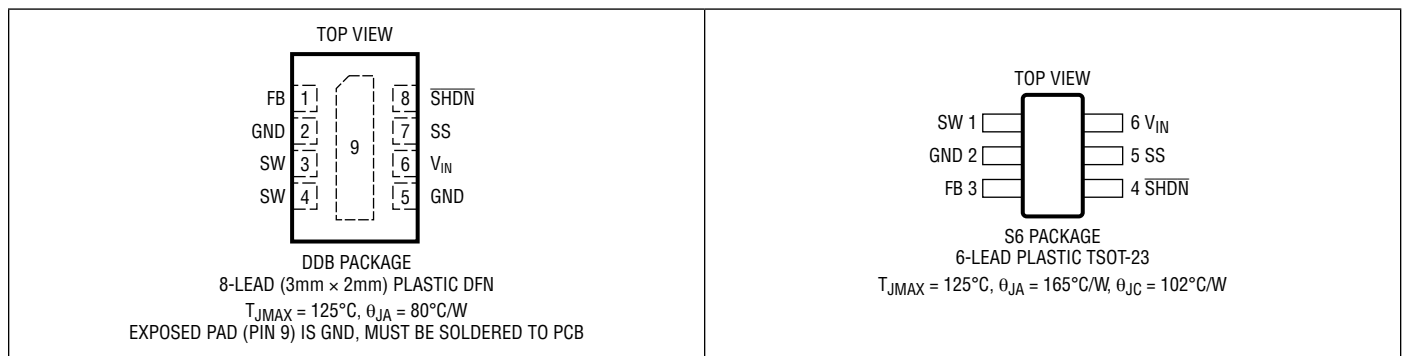
LT3467/LT3467A

ABSOLUTE MAXIMUM RATINGS (Note 1)

V_{IN} Voltage.....	16V
SW Voltage	-0.4V to 42V
FB Voltage.....	2.5V
Current Into FB Pin	± 1 mA
$\overline{\text{SHDN}}$ Voltage	16V
Maximum Junction Temperature	125°C

Operating Junction Temperature Range (Note 2)	
E-Grade.....	-40°C to 85°C
I-Grade.....	-40°C to 125°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec)	
TSOT.....	300°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3467EDDB#PBF	LT3467EDDB#TRPBF	LCPX	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 85°C
LT3467IDDB#PBF	LT3467IDDB#TRPBF	LCPX	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 125°C
LT3467AEDDB#PBF	LT3467AEDDB#TRPBF	LCKD	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 85°C
LT3467AIDDB#PBF	LT3467AIDDB#TRPBF	LCKD	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 125°C
LT3467IS6#PBF	LT3467IS6#TRPBF	LTACH	6-Lead Plastic TSOT-23	-40°C to 125°C
LT3467ES6#PBF	LT3467ES6#TRPBF	LTACH	6-Lead Plastic TSOT-23	-40°C to 85°C
LT3467AES6#PBF	LT3467AES6#TRPBF	LTBCC	6-Lead Plastic TSOT-23	-40°C to 85°C
LT3467AIS6#PBF	LT3467AIS6#TRPBF	LTBCC	6-Lead Plastic TSOT-23	-40°C to 125°C
LEAD BASED FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3467EDDB	LT3467EDDB#TR	LCPX	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 85°C
LT3467IDDB	LT3467IDDB#TR	LCPX	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 125°C
LT3467AEDDB	LT3467AEDDB#TR	LCKD	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 85°C
LT3467AIDDB	LT3467AIDDB#TR	LCKD	8-Lead (3mm x 2mm) Plastic DFN	-40°C to 125°C
LT3467IS6	LT3467IS6#TR	LTACH	6-Lead Plastic TSOT-23	-40°C to 125°C
LT3467ES6	LT3467ES6#TR	LTACH	6-Lead Plastic TSOT-23	-40°C to 85°C
LT3467AES6	LT3467AES6#TR	LTBCC	6-Lead Plastic TSOT-23	-40°C to 85°C
LT3467AIS6	LT3467AIS6#TR	LTBCC	6-Lead Plastic TSOT-23	-40°C to 125°C

ORDER INFORMATION

TAPE AND REEL (MINI)	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
AUTOMOTIVE PRODUCTS**				
LT3467AIS6#WTRMPBF	LT3467AIS6#WTRPBF	LTBCC	6-Lead Plastic TSOT-23	-40°C to 125°C

TRM = 500 pieces. *Temperature grades are identified by a label on the shipping container.

Contact the factory for parts specified with wider operating temperature ranges.

Tape and reel specifications. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

**Versions of this part are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. These model are designated with a #W suffix. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{IN} = 3\text{V}$, $V_{SHDN} = V_{IN}$ unless otherwise noted. Specifications are for both the LT3467 and LT3467A unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Minimum Operating Voltage				2.2	2.4	V
Maximum Operating Voltage					16	V
Feedback Voltage		●	1.230 1.220	1.255	1.270 1.280	V V
FB Pin Bias Current	(Note 3)	●		10	50	nA
Quiescent Current	$V_{SHDN} = 2.4\text{V}$, Not Switching			1.2	2	mA
Quiescent Current in Shutdown	$V_{SHDN} = 0.5\text{V}$, $V_{IN} = 3\text{V}$			0.01	1	μA
Reference Line Regulation	$2.6\text{V} \leq V_{IN} \leq 16\text{V}$			0.01	0.05	%/V
Switching Frequency	LT3467 LT3467A LT3467A		1 1.6 1.6	1.3 2.1	1.6 2.7	MHz MHz MHz
Maximum Duty Cycle	LT3467 LT3467 LT3467A LT3467A	● ● ●	88 87 82 78	94 88		% % % %
Minimum Duty Cycle				10		%
Switch Current Limit	At Minimum Duty Cycle At Maximum Duty Cycle (Note 4)		1.4 0.8	1.8 1.2	2.5 1.9	A A
Switch V_{CESAT}	$I_{SW} = 1.1\text{A}$			330	500	mV
Switch Leakage Current	$V_{SW} = 5\text{V}$			0.01	1	μA
SHDN Input Voltage High			2.4			V
SHDN Input Voltage Low					0.5	V
SHDN Pin Bias Current	$V_{SHDN} = 3\text{V}$ $V_{SHDN} = 0\text{V}$			16 0	32 0.1	μA μA
SS Charging Current	$V_{SS} = 0.5\text{V}$		2	3	4.5	μA

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LT3467E/LT3467AE are guaranteed to meet performance specifications from 0°C to 85°C, junction temperature. Specifications over the -40°C to 85°C operating junction temperature range are assured by

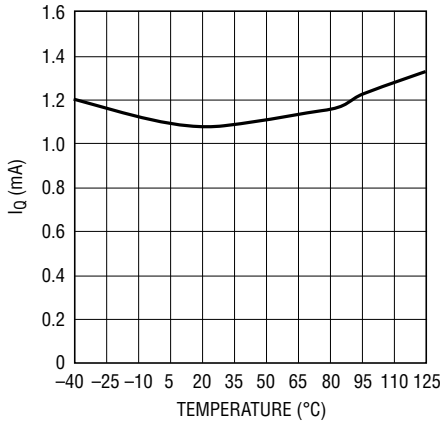
design, characterization and correlation with statistical process controls. The LT3467I/LT3467AI are guaranteed over the full -40°C to 125°C operating junction temperature range.

Note 3: Current flows out of the pin.

Note 4: See Typical Performance Characteristics for guaranteed current limit vs duty cycle.

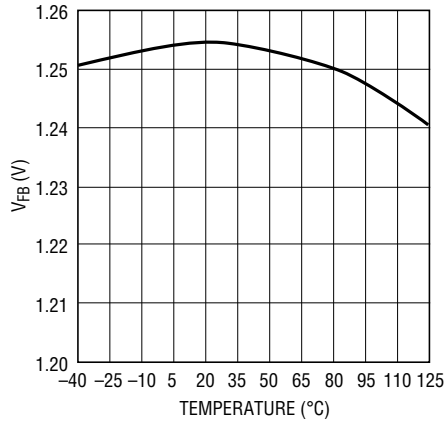
TYPICAL PERFORMANCE CHARACTERISTICS

Quiescent Current vs Temperature



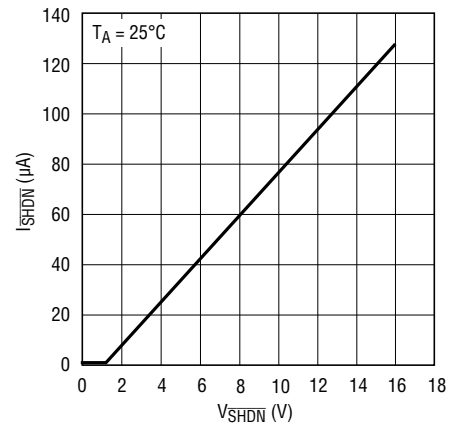
3467 G01

FB Pin Voltage vs Temperature



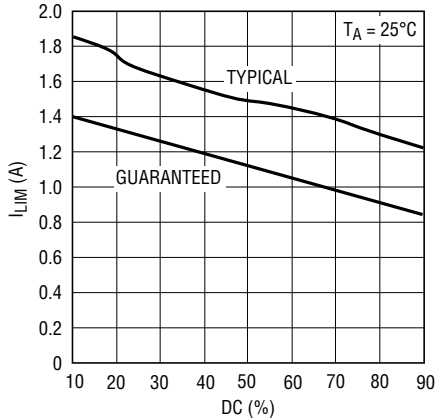
3467 G02

SHDN Current vs SHDN Voltage



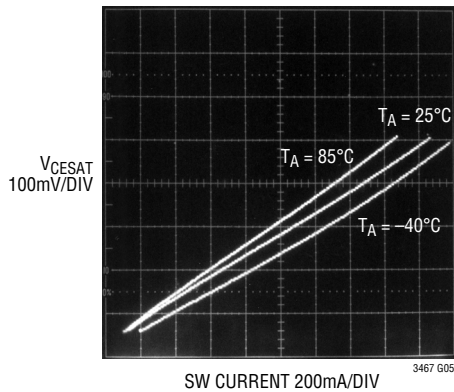
3467 G03

Current Limit vs Duty Cycle



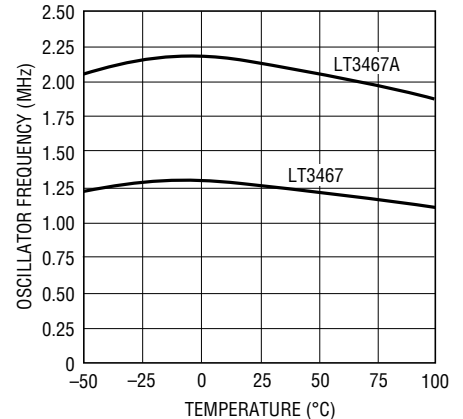
3467 G04

Switch Saturation Voltage vs Switch Current



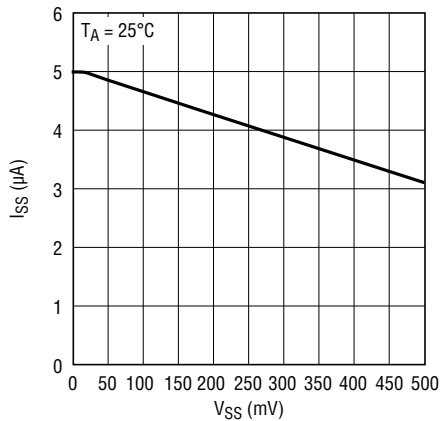
3467 G05

Oscillator Frequency vs Temperature



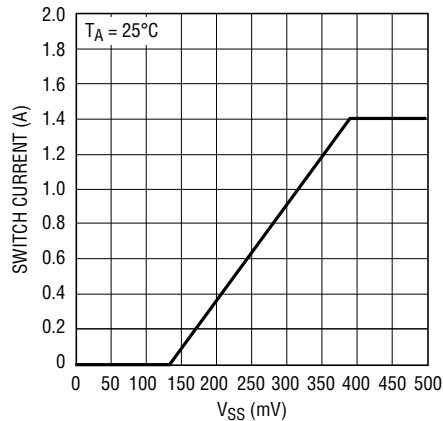
3467 G06

Soft-Start Current vs Soft-Start Voltage



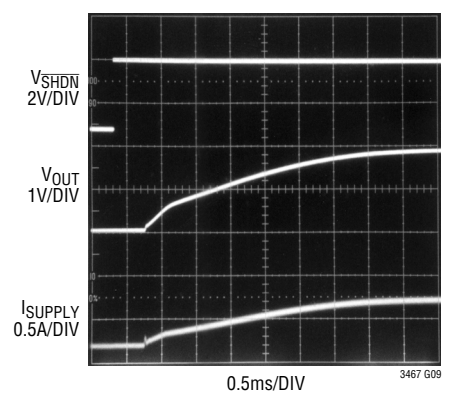
3467 G07

Peak Switch Current vs Soft-Start Voltage



3467 G08

Start-Up Waveform (Figure 2 Circuit)



3467 G09

PIN FUNCTIONS (DFN/TSOT)

FB (Pin 1/Pin 3): Feedback Pin. Reference voltage is 1.255V. Connect resistive divider tap here. Minimize trace area at FB. Set $V_{OUT} = 1.255V(1 + R1/R2)$.

GND (Pins 2, 5, 9/Pin 2): Ground. Tie directly to local ground plane.

SW (Pins 3, 4/Pin 1): Switch Pin. (Collector of internal NPN power switch) Connect inductor/diode here and minimize the metal trace area connected to this pin to minimize EMI.

V_{IN} (Pin 6/Pin 6): Input Supply Pin. Must be locally bypassed.

SS (Pin 7/Pin 5): Soft-Start Pin. Place a soft-start capacitor here. Upon start-up, 4 μ A of current charges the capacitor to 1.255V. Use a larger capacitor for slower start-up. Leave floating if not in use.

SHDN (Pin 8/Pin 4): Shutdown Pin. Tie to 2.4V or more to enable device. Ground to shut down.

BLOCK DIAGRAM

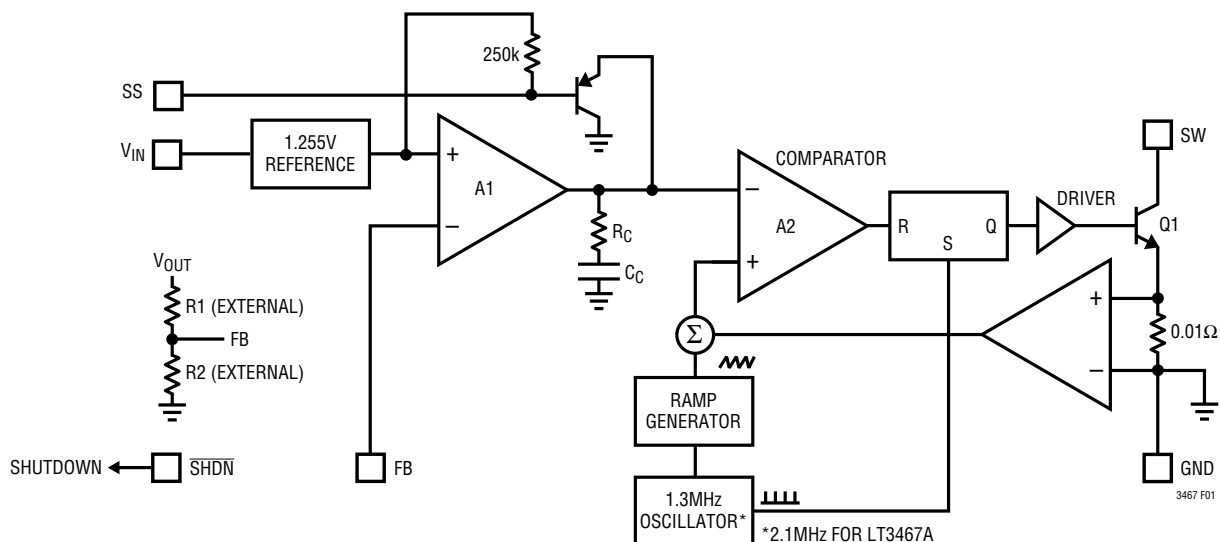


Figure 1. Block Diagram

OPERATION

The LT3467 uses a constant frequency, current-mode control scheme to provide excellent line and load regulation. Refer to the Block Diagram. At the start of each oscillator cycle, the SR latch is set which turns on the power switch Q1. A voltage proportional to the switch current is added to a stabilizing ramp and the resulting sum is fed into the positive terminal of the PWM comparator A2. When this voltage exceeds the level at the negative input of A2, the SR latch is reset, turning off the power switch. The level at the negative input of A2 is set by the error amplifier A1, and is simply an amplified version of the difference between the feedback voltage and the reference voltage of 1.255V. In this manner, the error amplifier sets the correct peak current level to keep the output in regulation. If the error amplifier's output increases, more current is delivered to the output. Similarly, if the error decreases, less current is delivered. The soft-start feature of the

LT3467 allows for clean start-up conditions by limiting the rate of voltage rise at the output of comparator A1 which, in turn, limits the peak switch current. The soft-start pin is connected to a reference voltage of 1.255V through a 250k resistor, providing 4μA of current to charge the soft-start capacitor. Typical values for the soft-start capacitor range from 10nF to 200nF. The LT3467 has a current limit circuit not shown in the Block Diagram. The switch current is constantly monitored and not allowed to exceed the maximum switch current (typically 1.4A). If the switch current reaches this value, the SR latch is reset regardless of the state of comparator A2. This current limit protects the power switch as well as the external components connected to the LT3467.

The Block Diagram for the LT3467A (not shown) is identical except that the oscillator frequency is 2.1MHz.

APPLICATIONS INFORMATION

Duty Cycle

The typical maximum duty cycle of the LT3467 is 94% (88% for the LT3467A). The duty cycle for a given application is given by:

$$DC = \frac{|V_{OUT}| + |V_D| - |V_{IN}|}{|V_{OUT}| + |V_D| - |V_{CESAT}|}$$

where V_D is the diode forward voltage drop and V_{CESAT} is in the worst case 330mV (at 1.1A)

The LT3467 and LT3467A can be used at higher duty cycles, but must be operated in the discontinuous conduction mode so that the actual duty cycle is reduced.

Setting Output Voltage

R1 and R2 determine the output voltage.

$$V_{OUT} = 1.255V (1 + R1/R2)$$

Switching Frequency and Inductor Selection

The LT3467 switches at 1.3 MHz, allowing for small valued inductors to be used. 4.7μH or 10μH will usually suffice. The LT3467A switches at 2.1MHz, allowing for even smaller valued inductors to be used. 0.9μH to 6.8μH will usually suffice. Choose an inductor that can handle at least 1.2A without saturating, and ensure that the inductor has a low DCR (copper-wire resistance) to minimize I^2R power losses. Note that in some applications, the current handling requirements of the inductor can be lower, such as in the SEPIC topology where each inductor only carries one-half of the total switch current. For better efficiency, use similar valued inductors with a larger volume. Many different sizes and shapes are available from various manufacturers. Choose a core material that has low losses at 1.3MHz, (2.1MHz for the LT3467A) such as ferrite core.

APPLICATIONS INFORMATION

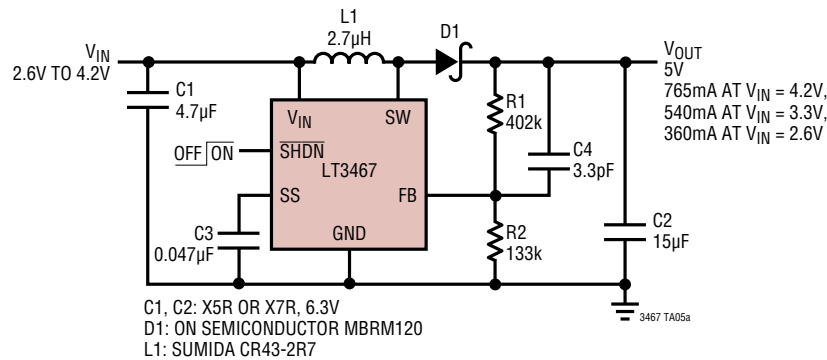


Figure 2. Single Li-Ion Cell to 5V Boost Converter (Same as 1st Page Application)

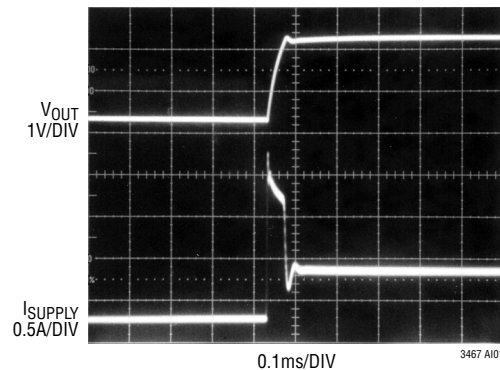
Table 1. Inductor Manufacturers

MANUFACTURER	WEB
Sumida	www.sumida.com
TDK	www.tdk.com
Murata	www.murata.com
FDK	www.fdk.co.jp

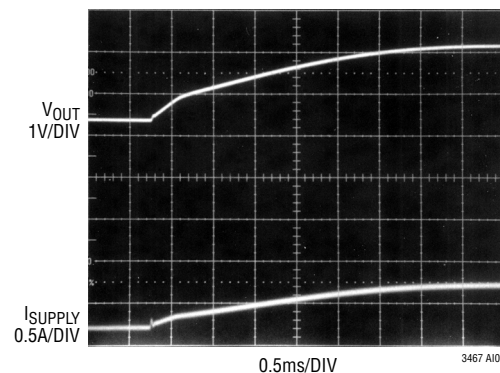
Soft-Start

The soft-start feature provides a way to limit the inrush current drawn from the supply upon start-up. An internal 250k resistor charges the external soft-start capacitor to 1.255V. After the capacitor reaches 0.15V the rate of voltage rise at the output of the comparator A1 tracks the rate of voltage rise of the soft-start capacitor. This limits the inrush current drawn from the supply during start-up. The soft-start feature plays another important role in applications where the switch will reach levels of 30V or higher. During start-up, excessively high switch current, together with the presence of high voltage can overstress the switch. A properly used soft-start feature will keep the switch current from overshooting. This practice will greatly improve the robustness of such designs. Once the part is shut down, the soft-start capacitor is quickly discharged to 0.4V, then slowly discharged through the 250k resistor to ground. If the part is to be shut down and re-enabled in a short period of time while soft-start is used, you must ensure that the soft-start capacitor has enough time to discharge before re-enabling the part. Typical values of the soft-start capacitor range from 10nF to 200nF.

Supply Current of Figure 2 During Start-Up Without Soft-Start Capacitor



Supply Current of Figure 2 During Start-Up with a 47nF Soft-Start Capacitor



APPLICATIONS INFORMATION

Capacitor Selection

Low ESR (equivalent series resistance) capacitors should be used at the output to minimize the output ripple voltage. Multi-layer ceramic capacitors are an excellent choice, as they have extremely low ESR and are available in very small packages. X5R dielectrics are preferred, followed by X7R, as these materials retain the capacitance over wide voltage and temperature ranges. A 4.7μF to 15μF output capacitor is sufficient for most applications, but systems with very low output currents may need only a 1μF or 2.2μF output capacitor. Solid tantalum or OS-CON capacitors can be used, but they will occupy more board area than a ceramic and will have a higher ESR. Always use a capacitor with a sufficient voltage rating.

Ceramic capacitors also make a good choice for the input decoupling capacitor, which should be placed as close as possible to the LT3467. A 1μF to 4.7μF input capacitor is sufficient for most applications. Table 2 shows a list of several ceramic capacitor manufacturers. Consult the manufacturers for detailed information on their entire selection of ceramic parts.

Table 2. Ceramic Capacitor Manufacturers

MANUFACTURER	WEB
Taiyo Yuden	www.t-yuden.com
AVX	www.avxcorp.com
Murata	www.murata.com

The decision to use either low ESR (ceramic) capacitors or the higher ESR (tantalum or OS-CON) capacitors can affect the stability of the overall system. The ESR of any capacitor, along with the capacitance itself, contributes a zero to the system. For the tantalum and OS-CON capacitors, this zero is located at a lower frequency due to the higher value of the ESR, while the zero of a ceramic

capacitor is at a much higher frequency and can generally be ignored.

A phase lead zero can be intentionally introduced by placing a capacitor (C4) in parallel with the resistor (R1) between V_{OUT} and V_{FB} as shown in Figure 2. The frequency of the zero is determined by the following equation.

$$f_z = \frac{1}{2\pi \cdot R1 \cdot C4}$$

By choosing the appropriate values for the resistor and capacitor, the zero frequency can be designed to improve the phase margin of the overall converter. The typical target value for the zero frequency is between 35kHz to 55kHz. Figure 3 shows the transient response of the step-up converter from Figure 8 without the phase lead capacitor C4. Although adequate for many applications, phase margin is not ideal as evidenced by 2-3 “bumps” in both the output voltage and inductor current. A 22pF capacitor for C4 results in ideal phase margin, which is revealed in Figure 4 as a more damped response and less overshoot.

Diode Selection

A Schottky diode is recommended for use with the LT3467 and the LT3467A. The Philips PMEG 2005 is a very good choice. Where the switch voltage exceeds 20V, use the PMEG 3005 (a 30V diode). Where the switch voltage exceeds 30V, use the PMEG 4005 (a 40V diode). These diodes are rated to handle an average forward current of 0.5A. In applications where the average forward current of the diode exceeds 0.5A, a Philips PMEG 2010 rated at 1A is recommended. For higher efficiency, use a diode with better thermal characteristics such as the On Semiconductor MBRM120 (a 20V diode) or the MBRM140 (a 40V diode).

APPLICATIONS INFORMATION

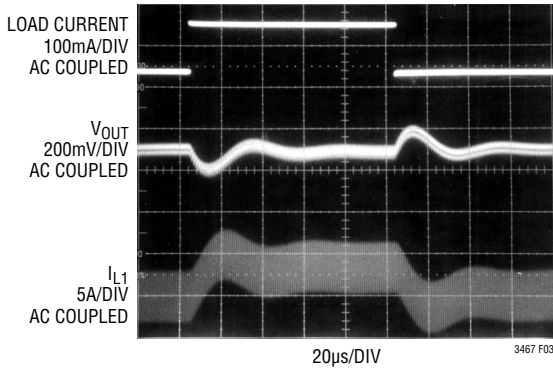


Figure 3. Transient Response of Figure 8's Step-Up Converter without Phase Lead Capacitor

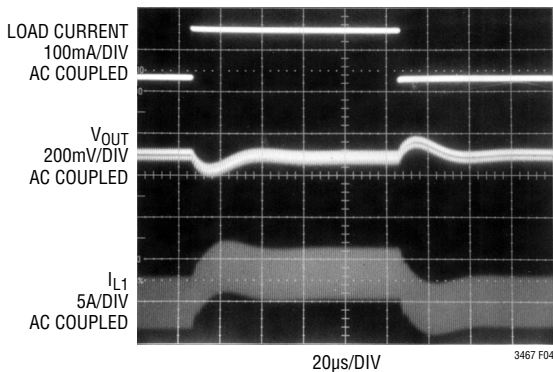


Figure 4. Transient Response of Figure 8's Step-Up Converter with a 22pF Phase Lead Capacitor

Setting Output Voltage

To set the output voltage, select the values of R1 and R2 (see Figure 2) according to the following equation.

$$R1 = R2 \left(\frac{V_{OUT}}{1.255V} - 1 \right)$$

A good value for R2 is 13.3k which sets the current in the resistor divider chain to $1.255V/13.3k = 94\mu A$.

Layout Hints

The high speed operation of the LT3467/LT3467A demands careful attention to board layout. You will not get advertised performance with careless layout. Figure 5a shows the recommended component placement for the ThinSOT package. Figure 5b shows the recommended component placement for the DFN package. Note the vias under the Exposed Pad. These should connect to a local ground plane for better thermal performance.

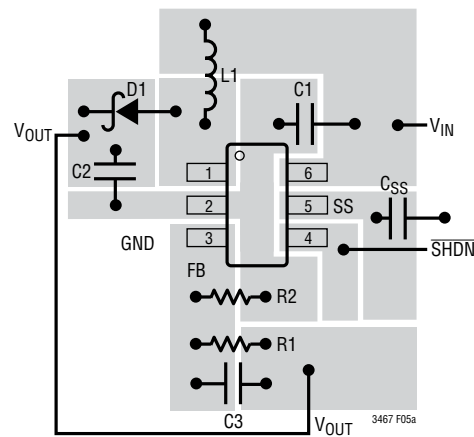


Figure 5a. Suggested Layout—ThinSOT

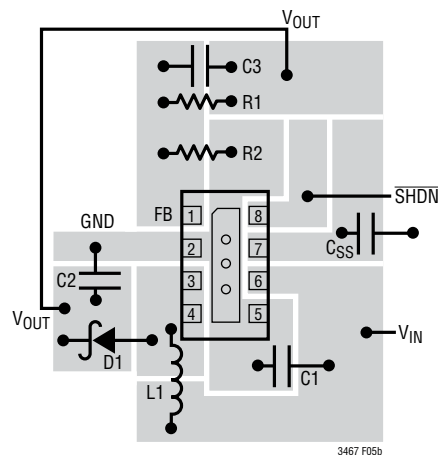


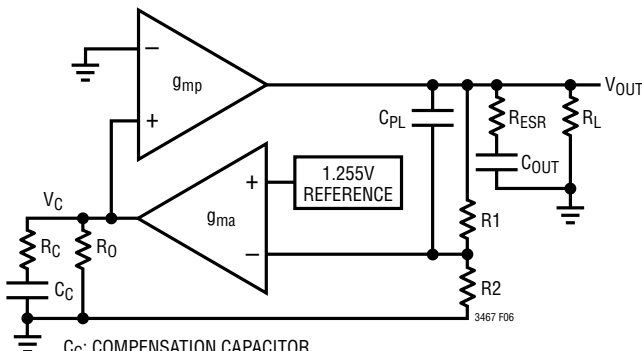
Figure 5b. Suggested Layout—DFN

APPLICATIONS INFORMATION

Compensation—Theory

Like all other current mode switching regulators, the LT3467/LT3467A needs to be compensated for stable and efficient operation. Two feedback loops are used in the LT3467/LT3467A: a fast current loop which does not require compensation, and a slower voltage loop which does. Standard Bode plot analysis can be used to understand and adjust the voltage feedback loop.

As with any feedback loop, identifying the gain and phase contribution of the various elements in the loop is critical. Figure 6 shows the key equivalent elements of a boost converter. Because of the fast current control loop, the power stage of the IC, inductor and diode have been replaced by the equivalent transconductance amplifier g_{mp} . g_{mp} acts as a current source where the output current is proportional to the V_C voltage. Note that the maximum output current of g_{mp} is finite due to the current limit in the IC.



C_C : COMPENSATION CAPACITOR
 C_{OUT} : OUTPUT CAPACITOR
 C_{PL} : PHASE LEAD CAPACITOR
 g_{ma} : TRANSCONDUCTANCE AMPLIFIER INSIDE IC
 g_{mp} : POWER STAGE TRANSCONDUCTANCE AMPLIFIER
 R_C : COMPENSATION RESISTOR
 R_L : OUTPUT RESISTANCE DEFINED AS V_{OUT} DIVIDED BY $I_{LOAD(MAX)}$
 R_O : OUTPUT RESISTANCE OF g_{ma}
 R_1, R_2 : FEEDBACK RESISTOR DIVIDER NETWORK
 R_{ESR} : OUTPUT CAPACITOR ESR

Figure 6. Boost Converter Equivalent Model

From Figure 6, the DC gain, poles and zeroes can be calculated as follows:

$$\text{Output Pole: } P1 = \frac{2}{2 \cdot \pi \cdot R_L \cdot C_{OUT}}$$

$$\text{Error Amp Pole: } P2 = \frac{1}{2 \cdot \pi \cdot R_O \cdot C_C}$$

$$\text{Error Amp Zero: } Z1 = \frac{1}{2 \cdot \pi \cdot R_C \cdot C_C}$$

$$\text{DC GAIN: } A = \frac{1.255}{V_{OUT}^2} \cdot V_{IN} \cdot g_{ma} \cdot R_O \cdot g_{mp} \cdot R_L \cdot \frac{1}{2}$$

$$\text{ESR Zero: } Z2 = \frac{1}{2 \cdot \pi \cdot R_{ESR} \cdot C_{OUT}}$$

$$\text{RHP Zero: } Z3 = \frac{V_{IN}^2 \cdot R_L}{2 \cdot \pi \cdot V_{OUT}^2 \cdot L}$$

$$\text{High Frequency Pole: } P3 > \frac{f_s}{3}$$

$$\text{Phase Lead Zero: } Z4 = \frac{1}{2 \cdot \pi \cdot R1 \cdot C_{PL}}$$

$$\text{Phase Lead Pole: } P4 = \frac{1}{2 \cdot \pi \cdot C_{PL} \cdot \frac{R1 \cdot R2}{R1 + R2}}$$

The current mode zero is a right-half plane zero which can be an issue in feedback control design, but is manageable with proper external component selection.

APPLICATIONS INFORMATION

Using the circuit of Figure 2 as an example, the following table shows the parameters used to generate the Bode plot shown in Figure 7.

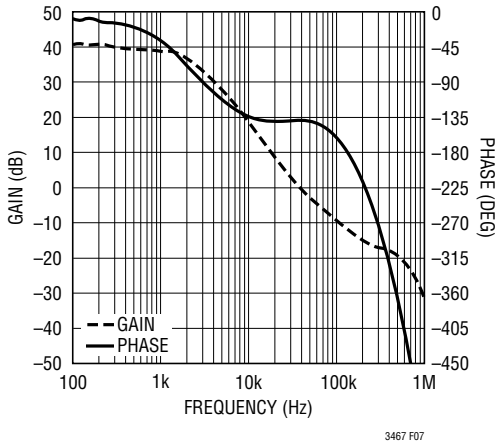


Figure 7. Bode Plot of 3.3V to 5V Application

Table 3. Bode Plot Parameters

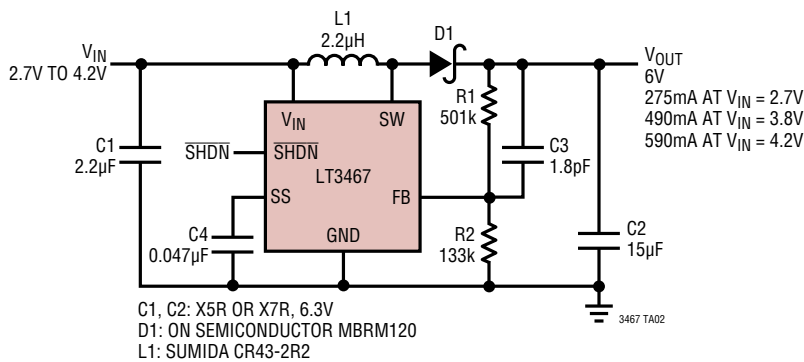
PARAMETER	VALUE	UNITS	COMMENT
R_L	10.4	Ω	Application Specific
C_{OUT}	15	μF	Application Specific
R_{ESR}	10	m Ω	Application Specific
R_O	0.4	M Ω	Not Adjustable
C_C	60	pF	Not Adjustable
C_{PL}	3.3	pF	Adjustable
R_C	100	k Ω	Not Adjustable
R_1	402	k Ω	Adjustable
R_2	133	k Ω	Adjustable
V_{OUT}	5	V	Application Specific
V_{IN}	3.3	V	Application Specific
g_{ma}	35	μmho	Not Adjustable
g_{mp}	7.5	mho	Not Adjustable
L	2.7	μH	Application Specific
f_S	1.3*	MHz	Not Adjustable

*2.1MHz for LT3467A

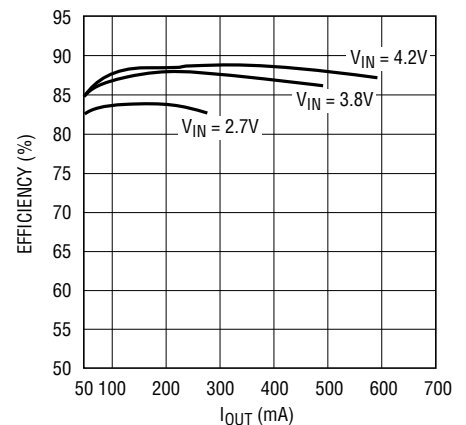
From Figure 7, the phase is -138° when the gain reaches 0dB giving a phase margin of 42° . This is more than adequate. The crossover frequency is 37kHz.

TYPICAL APPLICATIONS

Lithium-Ion to 6V Step-Up DC/DC Converter



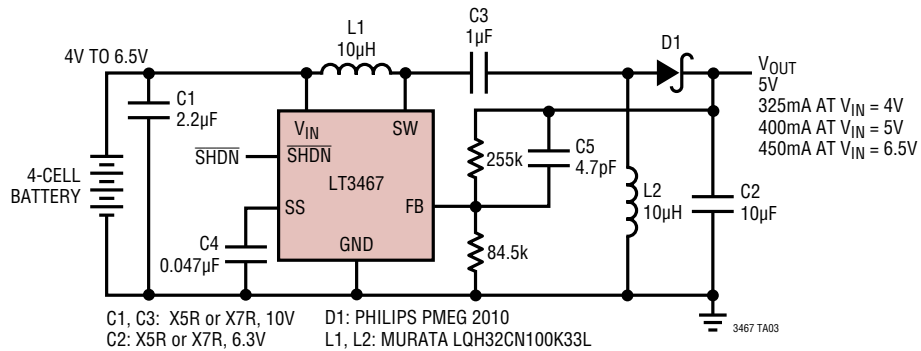
Li-Ion to 6V



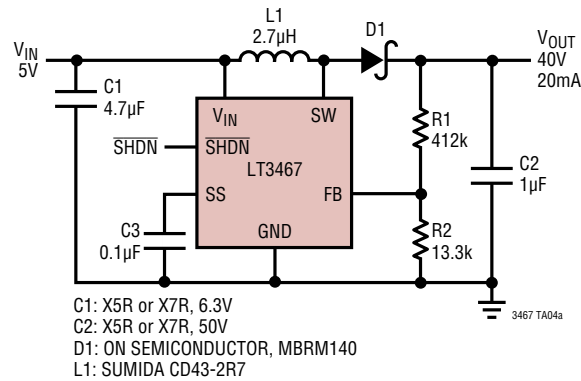
3467 TA02b

TYPICAL APPLICATIONS

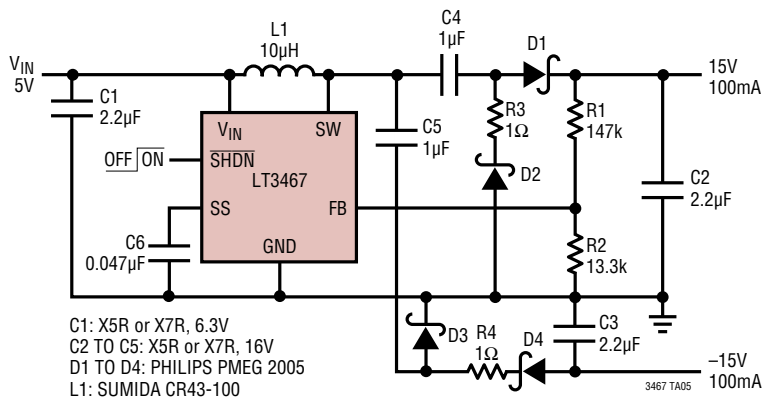
4-Cell to 5V SEPIC Converter



5V to 40V Boost Converter

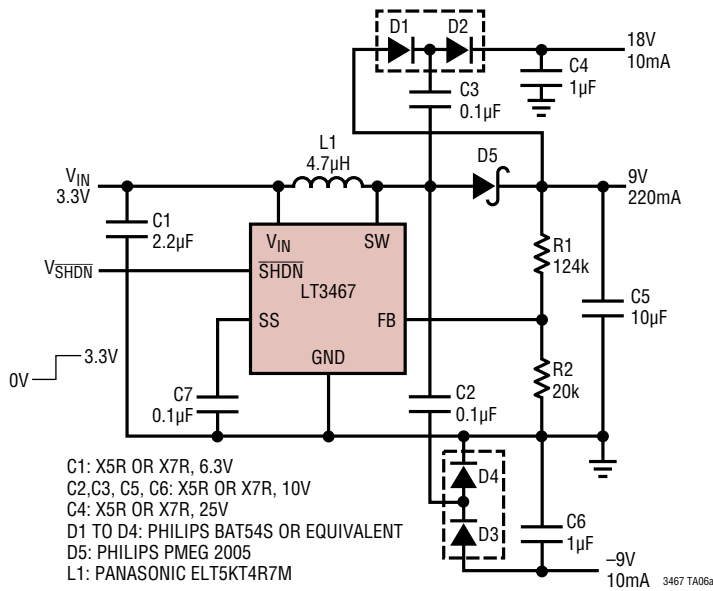


±15V Dual Output Converter with Output Disconnect

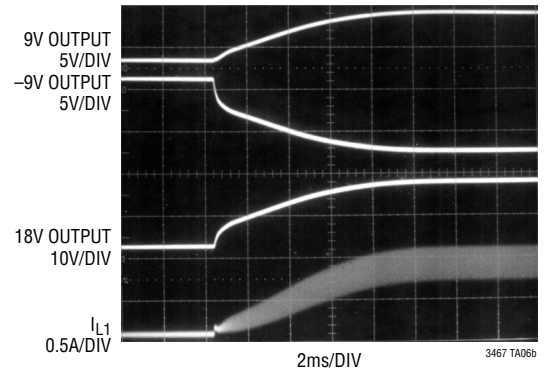


TYPICAL APPLICATIONS

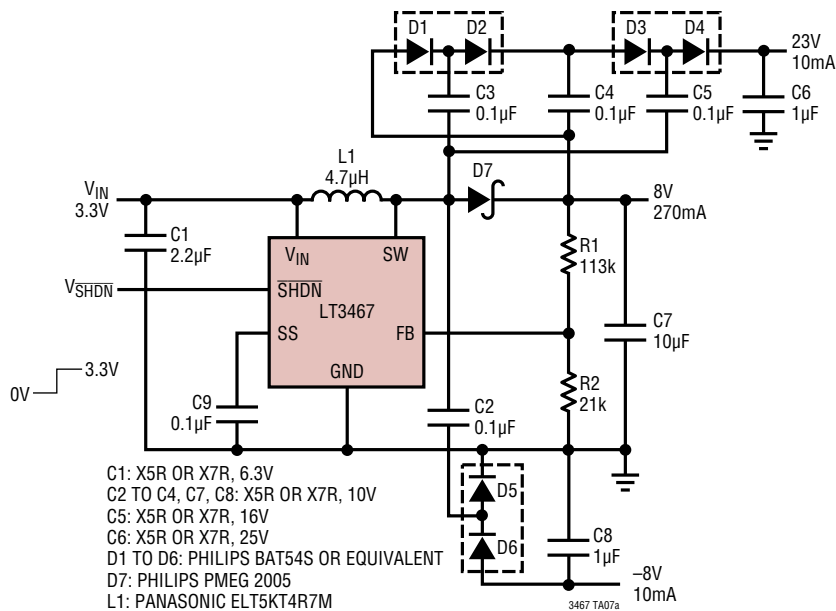
9V, 18V, -9V Triple Output TFT-LCD Bias Supply with Soft-Start



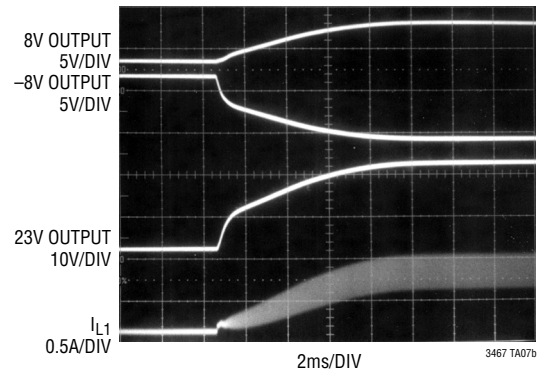
Start-Up Waveforms



8V, 23V, -8V Triple Output TFT-LCD Bias Supply with Soft-Start



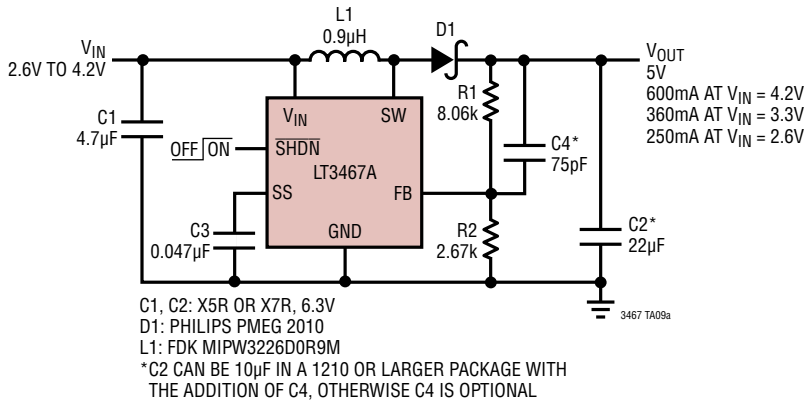
Start-Up Waveforms



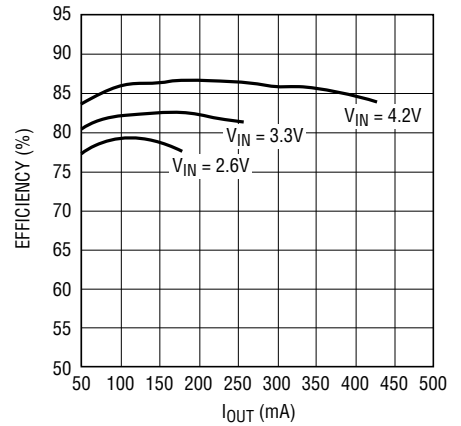
LT3467/LT3467A

TYPICAL APPLICATIONS

Single Li-Ion Cell to 5V Boost Converter

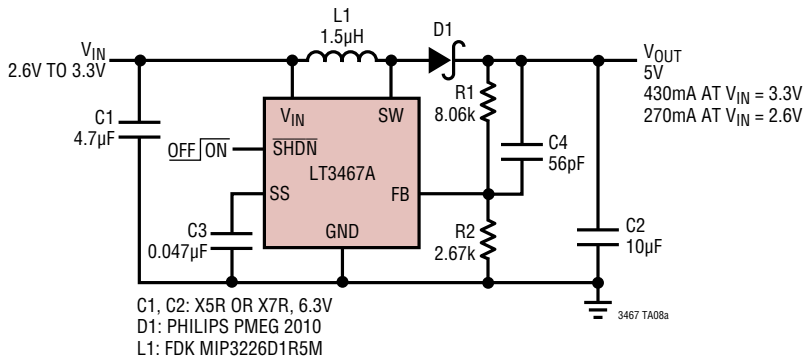


Efficiency

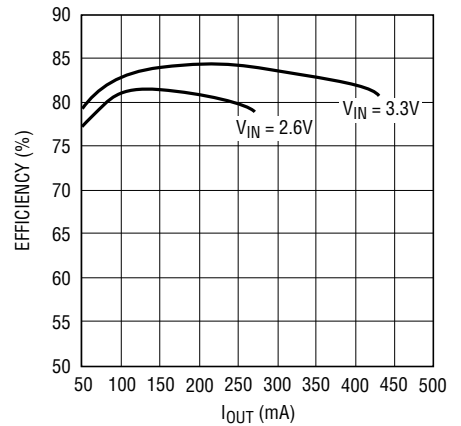


3467 TA09b

2.6V-3.3V to 5V Boost Converter

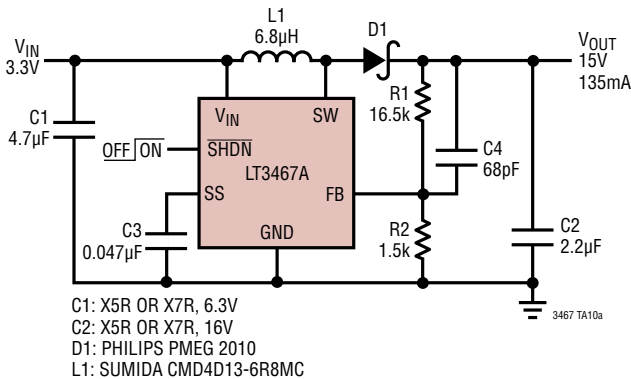


Efficiency

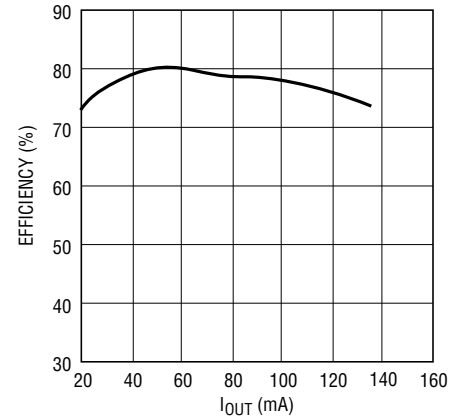


3467 TA08b

3.3V to 15V, 135mA Step-Up Converter



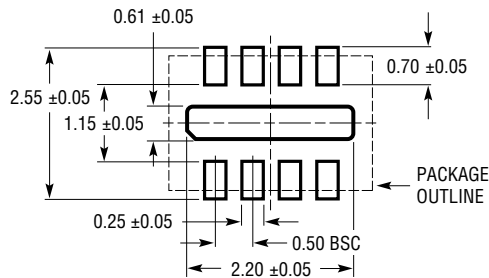
Efficiency



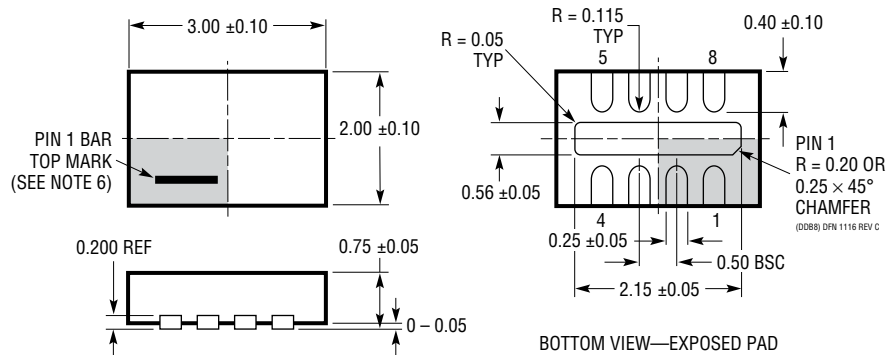
3467 TA10b

PACKAGE DESCRIPTION

DDB Package
8-Lead Plastic DFN (3mm × 2mm)
 (Reference LTC DWG # 05-08-1702 Rev C)



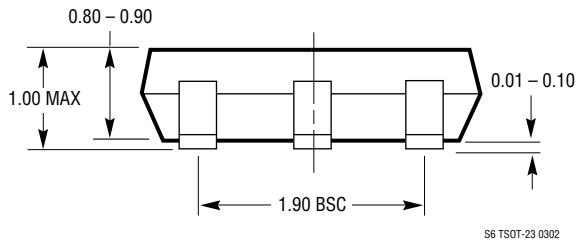
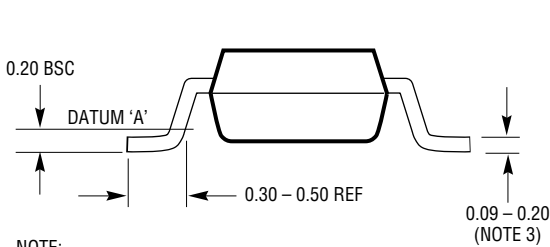
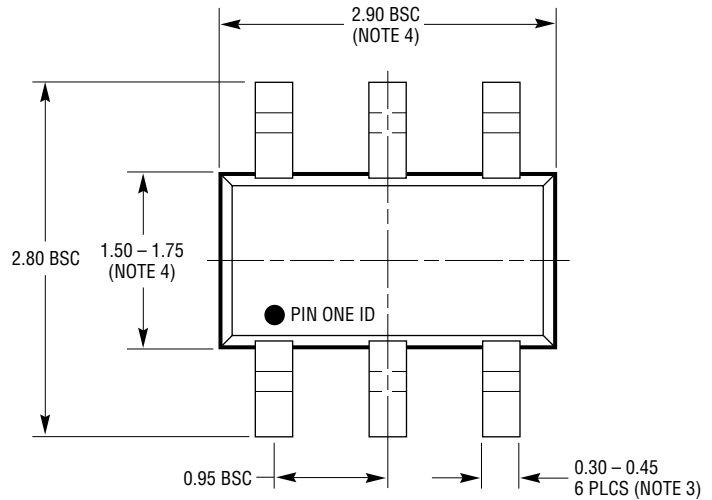
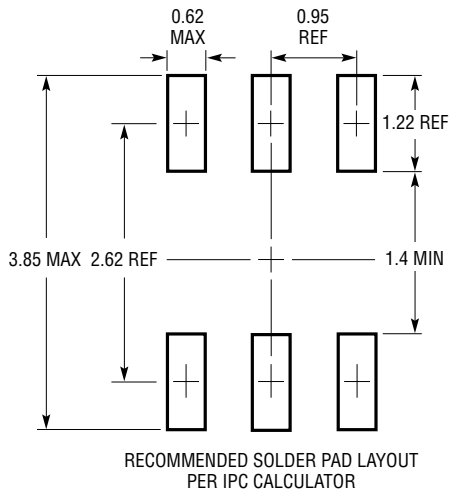
RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS



- NOTE:
1. DRAWING CONFORMS TO VERSION (WECD-1) IN JEDEC PACKAGE OUTLINE M0-229
 2. DRAWING NOT TO SCALE
 3. ALL DIMENSIONS ARE IN MILLIMETERS
 4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
 5. EXPOSED PAD SHALL BE SOLDER PLATED
 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

PACKAGE DESCRIPTION

S6 Package
6-Lead Plastic TSOT-23
 (Reference LTC DWG # 05-08-1636)



- NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
 2. DRAWING NOT TO SCALE
 3. DIMENSIONS ARE INCLUSIVE OF PLATING
 4. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
 5. MOLD FLASH SHALL NOT EXCEED 0.254mm
 6. JEDEC PACKAGE REFERENCE IS MO-193

REVISION HISTORY (Revision history begins at Rev E)

REV	DATE	DESCRIPTION	PAGE NUMBER
E	04/10	Updated Note 2 in Absolute Maximum Ratings and Electrical Characteristics.	2, 3
F	05/22	Added AEC-Q100 Qualified for Automotive Applications. Updated Order Information table.	1, 2
G	08/22	Fixed typo in Order Information table. Deleted phone numbers in Table 1 and Table 2.	3 7, 8

TYPICAL APPLICATIONS

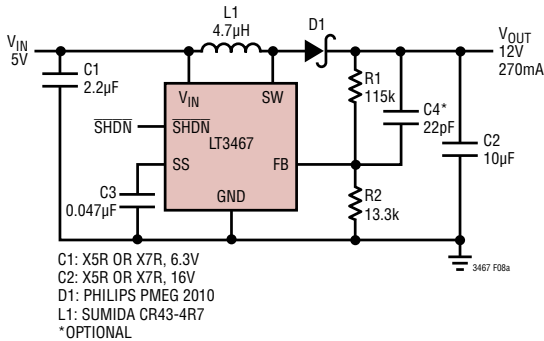


Figure 8. 5V to 12V, 270mA Step-Up Converter

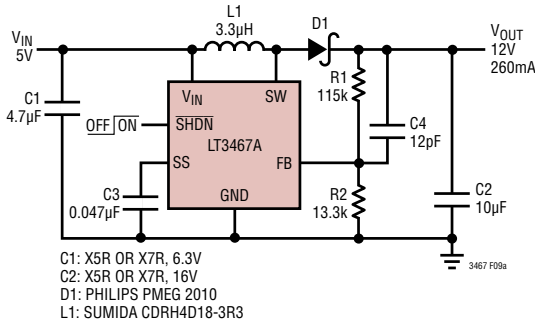
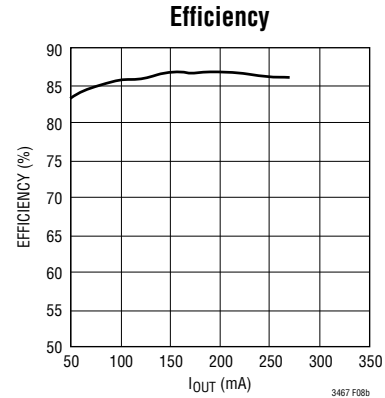
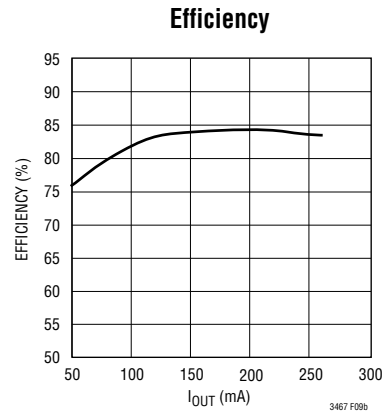


Figure 9. 5V to 12V, 260mA Step-Up Converter



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1615/LT1615-1	300mA/80mA (I_{SW}), High Efficiency Step-Up DC/DC Converter	V_{IN} : 1V to 15V, $V_{OUT(MAX)}$ = 34V, I_Q = 20µA, I_{SD} < 1µA, ThinSOT Package
LT1618	1.5A (I_{SW}), 1.25MHz, High Efficiency Step-Up DC/DC Converter	90% Efficiency, V_{IN} : 1.6V to 18V, $V_{OUT(MAX)}$ = 35V, I_Q = 1.8mA, I_{SD} < 1µA, MS Package
LTC1700	No R_{SENSE}^{TM} , 530kHz, Synchronous Step-Up DC/DC Controller	95% Efficiency, V_{IN} : 0.9V to 5V, I_Q = 200µA, I_{SD} < 10µA, MS Package
LTC1871	Wide Input Range, 1MHz, No R_{SENSE} Current Mode Boost, Flyback and SEPIC Controller	92% Efficiency, V_{IN} : 2.5V to 36V, I_Q = 250µA, I_{SD} < 10µA, MS Package
LT1930/LT1930A	1A (I_{SW}), 1.2MHz/2.2MHz, High Efficiency Step-Up DC/DC Converter	High Efficiency, V_{IN} : 2.6V to 16V, $V_{OUT(MAX)}$ = 34V, I_Q = 4.2mA/5.5mA, I_{SD} < 1µA, ThinSOT Package
LT1946/LT1946A	1.5A (I_{SW}), 1.2MHz/2.7MHz, High Efficiency Step-Up DC/DC Converter with Soft-Start	High Efficiency, V_{IN} : 2.45V to 16V, $V_{OUT(MAX)}$ = 34V, I_Q = 3.2mA, I_{SD} < 1µA, MS8 Package
LT1961	1.5A (I_{SW}), 1.25MHz, High Efficiency Step-Up DC/DC Converter	90% Efficiency, V_{IN} : 3V to 25V, $V_{OUT(MAX)}$ = 35V, I_Q = 0.9mA, I_{SD} < 6µA, MS8E Package
LTC3400/LTC3400B	600mA (I_{SW}), 1.2MHz, Synchronous Step-Up DC/DC Converter	92% Efficiency, V_{IN} : 0.85V to 5V, $V_{OUT(MAX)}$ = 5V, I_Q = 19µA/300µA, I_{SD} < 1µA, ThinSOT Package
LTC3401	1A (I_{SW}), 3MHz, Synchronous Step-Up DC/DC Converter	97% Efficiency, V_{IN} : 0.5V to 5V, $V_{OUT(MAX)}$ = 5.5V, I_Q = 38µA, I_{SD} < 1µA, MS Package
LTC3402	2A (I_{SW}), 3MHz, Synchronous Step-Up DC/DC Converter	97% Efficiency, V_{IN} : 0.5V to 5V, $V_{OUT(MAX)}$ = 5.5V, I_Q = 38µA, I_{SD} < 1µA, MS Package
LT3464	85mA (I_{SW}), High Efficiency Step-Up DC/DC Converter with Integrated Schottky and PNP Disconnect	V_{IN} : 2.3V to 10V, $V_{OUT(MAX)}$ = 34V, I_Q = 25µA, I_{SD} < 1µA, ThinSOT Package